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Applicant: Toru YAMADA, et al.

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For: Vapor Phase Growth Apparatus and Method of Fabricating Epitaxial Wafer

INFORMATION DISCLOSURE STATEMENT - PTO FORM 1449

U.S. PATENT DOCUMENTS			
Examiner Initials*	U.S. Patent Document Number	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY
/F.H./	6,153,260	Paul B. Comita et al.	11-28-2000

FOREIGN PATENT DOCUMENTS				
Examiner Initials*	Foreign Patent Document Number	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	T**
/F.H./	JP 2002-231641 w/ English Abstract	Shinetsu Handotai KK Nagano Electronics Ind	08-16-2002	
/F.H./	JP 2002-198316 w/ English Abstract	Shinetsu Handotai KK Nagano Electronics Ind	07-12-2002	
/F.H./	JP 2001-44125 w/ English Abstract	Applied Materials Inc	02-16-2001	
/F.H./	JP 2000-331939 w/ English Abstract	Applied Materials Inc	11-30-2000	
/F.H./	JP 11-45861	Applied Materials Inc	02-16-1999	2
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/F.H./	EP 0 637 058 A1	Applied Materials Inc	02-01-1995	
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Examiner Signature	/Felisa Hiteshew/	Date Considered	09/09/2008
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